

TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

TA8428K(S),TA8428F

FULL BRIDGE DRIVER

The TA8428K (S), TA8428F is Full Bridge Driver IC for Brush Motor Rotation Control.

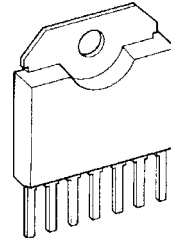
Forward Rotation, Reverse Rotation, Stop and Braking operations are available.

Thermal Shutdown and Short Current Protector are provided.

FEATURES

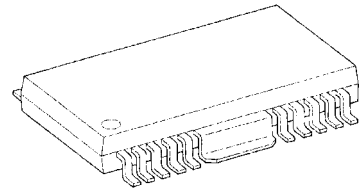
- Output Current : TA8428K (S) 1.5 A (AVE.), 3.0 A (PEAK)
TA8428F 0.8 A (AVE.), 2.4 A (PEAK)
- 4 modes (forward / reverse / short brake and stop) are available with 2 TTL compatible inputs control.
- Free wheeling diodes are equipped.
- Multi protection system driver
(Thermal shutdown and short current protector)

TA8428K (S)



HSIP7-P-2.54

TA8428F



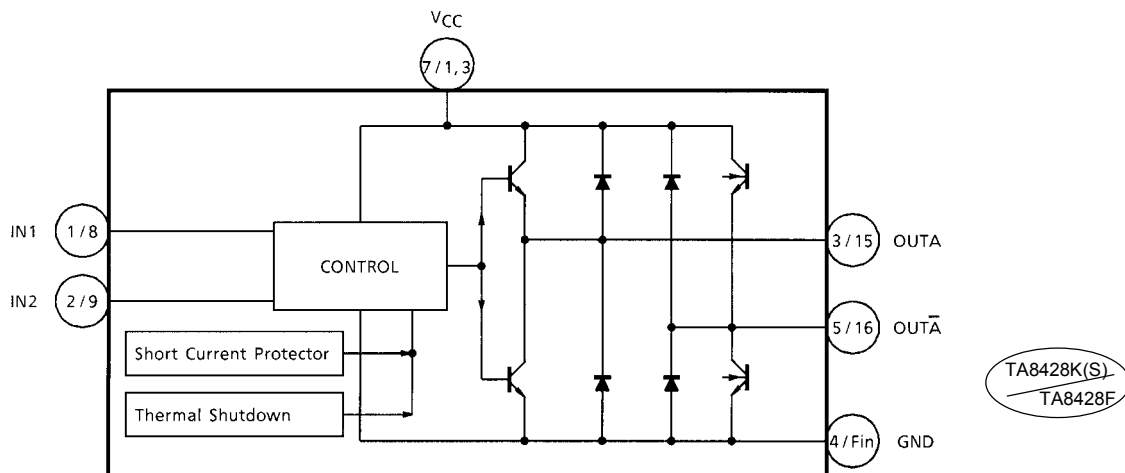
HSOP20-P-450-1.00

Weight

HSIP7-P-2.54 : 1.88 g (Typ.)

HSOP20-P-450-1.00 : 0.79 g (Typ.)

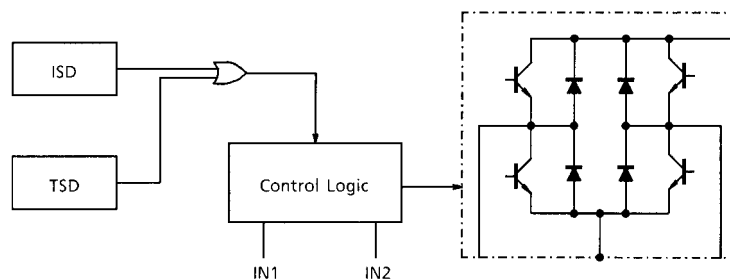
BLOCK DIAGRAM



PIN FUNCTION

PIN No.		SYMBOL	FUNCTIONAL DESCRIPTION
K(S)	F		
1	8	IN 1	TTL compatible control inputs. (PNP type low active comparator inputs)
2	9	IN 2	
3	15	OUTA	Output terminals and free wheeling diodes are connected between each output to GND and V_{CC} .
4	Fin	GND	GND terminal
5	16	OUT $\bar{A}$	Output terminals and free wheeling diodes are connected between each output to GND and V_{CC} .
6	Other pin	N.C	Non connection
7	1, 3	V_{CC}	Supply voltage terminal for control and motor drive.

TA8428K (S), TA8428F has 2 build-in protective functions which work independently. These circuit operations are as follows.

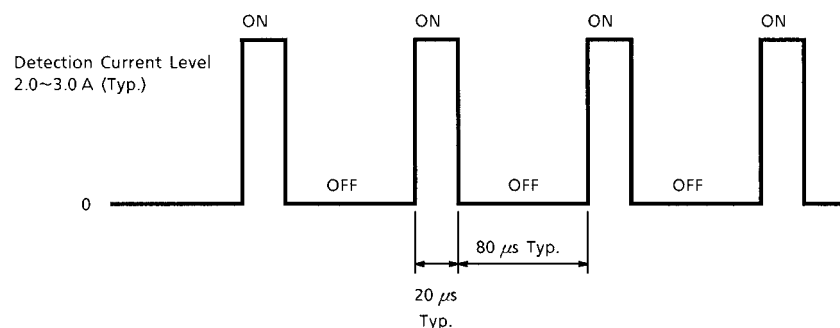


- Thermal shutdown (TSD)

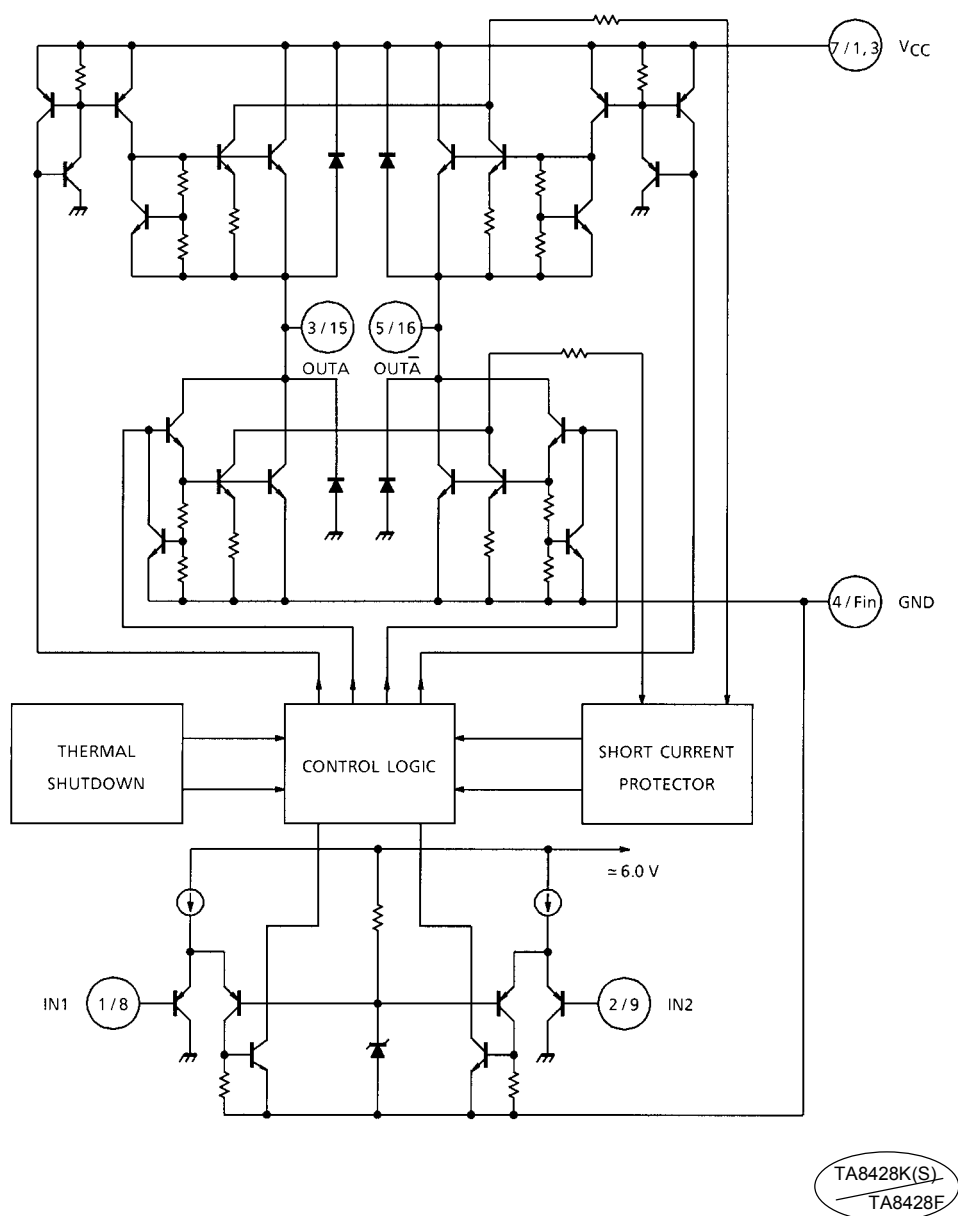
If junction temperature of TA8428K (S), TA8428F is over the specified temperature (150°C Typ.) by excess power dissipation or abnormal ambient temperature change, thermal Shutdown circuit turn "ON" and output 4 transistors become High impedance. (All transistors turn "OFF")

- Short current protector (ISD)

Short current protector circuit senses all output transistor current. If output transistor current is over the specified limiting current value (2.0~3.0 A Typ.), short current protector operates and all output transistors periodically turn "OFF" (High Impedance Mode) in a period of approximately 80 μ s. This state is continued until the release of over current mode.



INTERNAL CIRCUIT



MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC			SYMBOL	RATING	UNIT
Supply Voltage			V _{CC}	30	V
Input Voltage			V _{IN}	−0.3~V _{CC}	V
Output Current	K (S) type	PEAK	I _O (PEAK)	3.0 (Note 1)	A
		AVE.	I _O (AVE.)	1.5	
	F type	PEAK	I _O (PEAK)	2.4 (Note 1)	
		AVE.	I _O (AVE.)	0.8	
Power Dissipation		K (S) type	P _D	1.25 (Note 2)	W
				10.0 (Note 3)	
		F type	P _D	1.9 (Note 4)	
				2.5 (Note 5)	
Operating Temperature			T _{opr}	−30~85	°C
Storage Temperature			T _{stg}	−55~150	°C

Note 1: t = 100 ms

Note 2: No heat sink

Note 3: T_c = 85°C

Note 4: This value is obtained by 30 × 30 × 1.6 mm PCB mounting occupied copper area in excess of 60%

Note 5: This value is obtained by 50 × 50 × 1.6 mm PCB mounting occupied copper area in excess of 60%

ELECTRICAL CHARACTERISTICS (V_{CC} = 24 V, Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	Test Condition	MIN	TYP.	MAX	UNIT
Quiescent Current		I _{CC1}	1	Stop mode	—	8	15	mA
		I _{CC2}		Forward / reverse mode	—	35	85	
		I _{CC3}		Brake mode	—	16	30	
Input Voltage		V _{IL}	2	—	—	—	0.8	V
		V _{IH}		—	2.0	—	—	
Input Current		I _{IL}	2	V _{IN} = GND	—	—	50	μA
		I _{IH}		V _{IN} = V _{CC}	—	—	10	
Output Saturation Voltage	K (S) type	V _{sat} (total)	3	I _O = 1.5 A, T _c = 25°C	—	2.2	2.9	V
	F type			I _O = 0.8 A, T _c = 25°C	—	1.8	2.5	
Output Leakage Current		I _{LU}	4	V _L = 25 V	—	—	50	μA
		I _{LL}			—	—	50	
Diode Forward Voltage	K (S) type	I _{LU}	4	I _F = 1.5 A	—	2.6	—	V
		I _{LL}			—	1.5	—	
	F type	I _{LU}		I _F = 0.8 A	—	2.2	—	
		I _{LL}			—	1.2	—	
Thermal Shutdown Circuit Operating Temperature		T _{SD}	—	—	—	150	—	°C
Propagation Delay Time		t _{pLH}	2	—	—	1	—	μs
		t _{pHL}	2	—	—	1	—	

FUNCTION

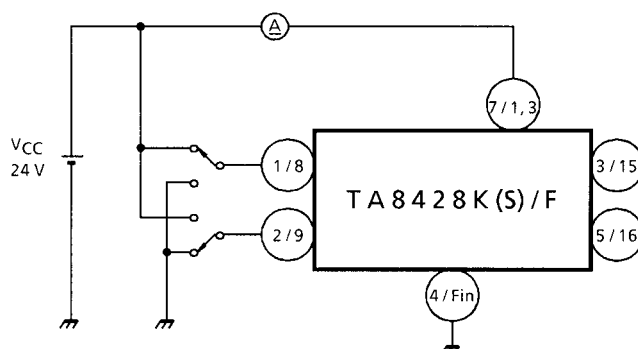
INPUT		OUTPUT		RATING
IN1	IN2	OUTA	OUT $\bar{A}$	
H	H	L	L	Brake
L	H	L	H	CW / CCW
H	L	H	L	CCW / CW
L	L	OFF (high impedance)		Stop

Note: PIN (6) is non connection.

Note: Heat fin is connected with GND with low impedance.

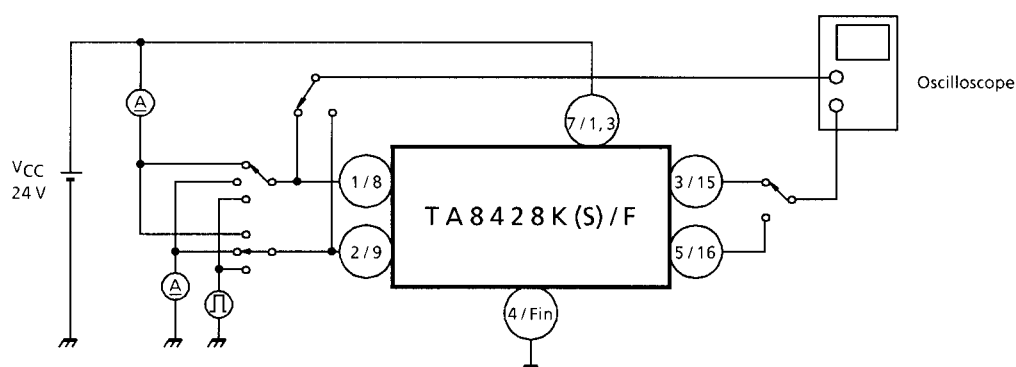
TEST CIRCUIT 1

I_{CC1} , I_{CC2} , I_{CC3}



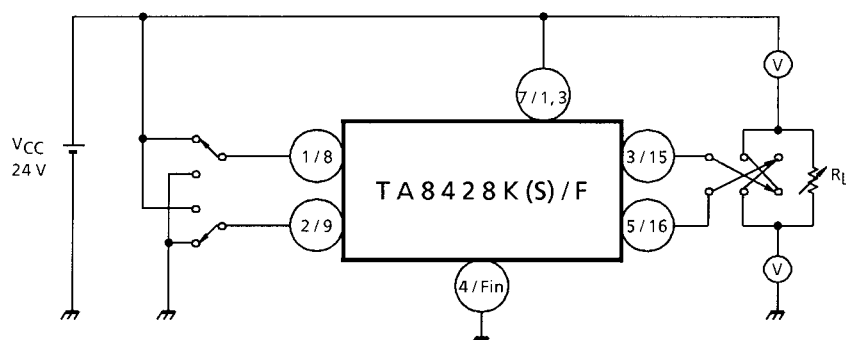
TEST CIRCUIT 2

V_{IL} , V_{IH} , I_{IL} , I_{IH} , t_{PLH} , t_{PHL}



TEST CIRCUIT 3

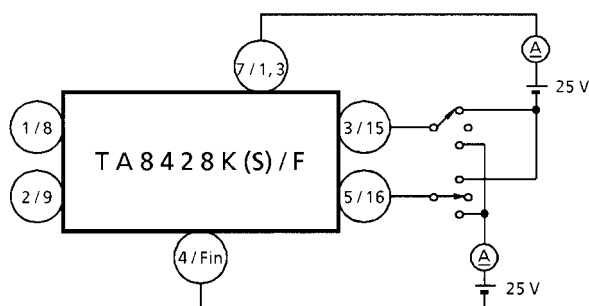
V_{sat}



TA8428K(S)
TA8428F

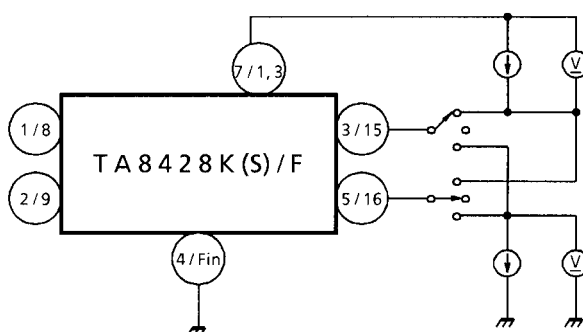
TEST CIRCUIT 4

I_{LH} , I_{LL}

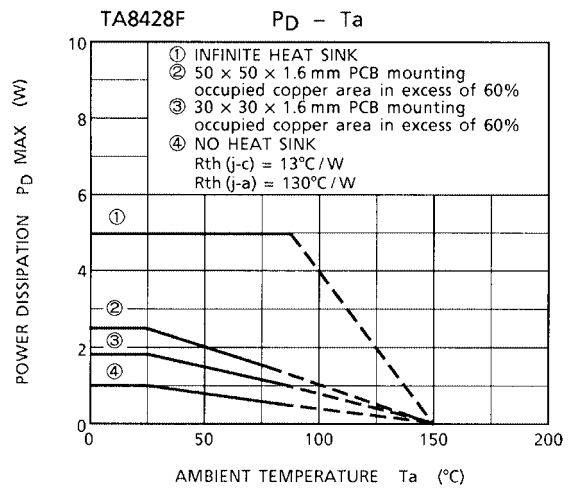
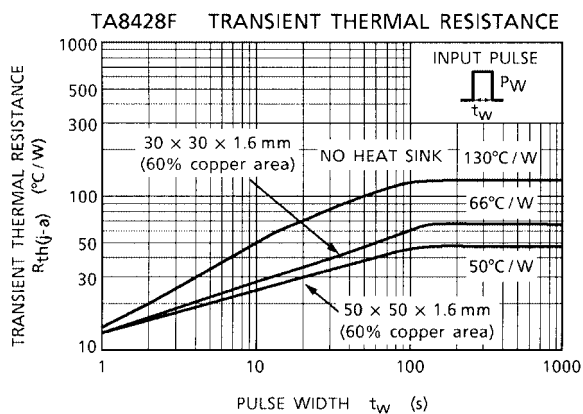
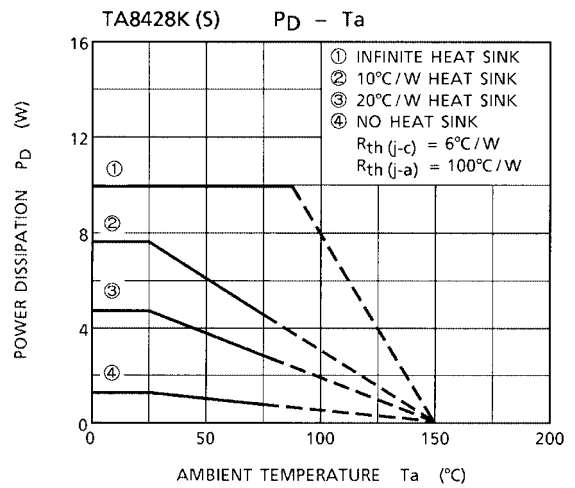
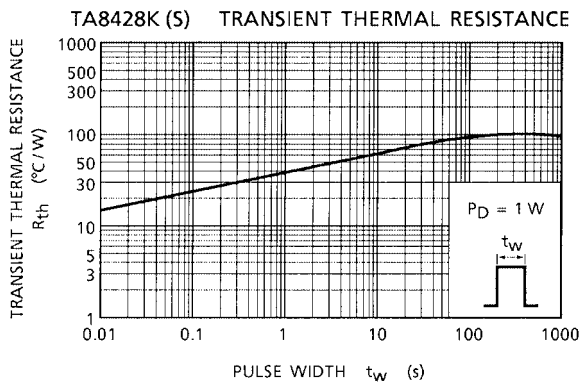
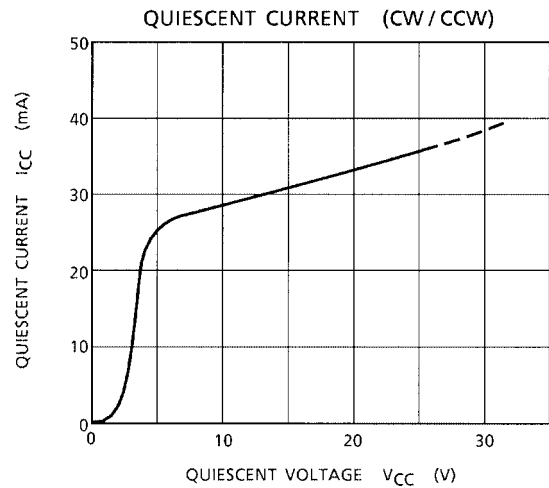
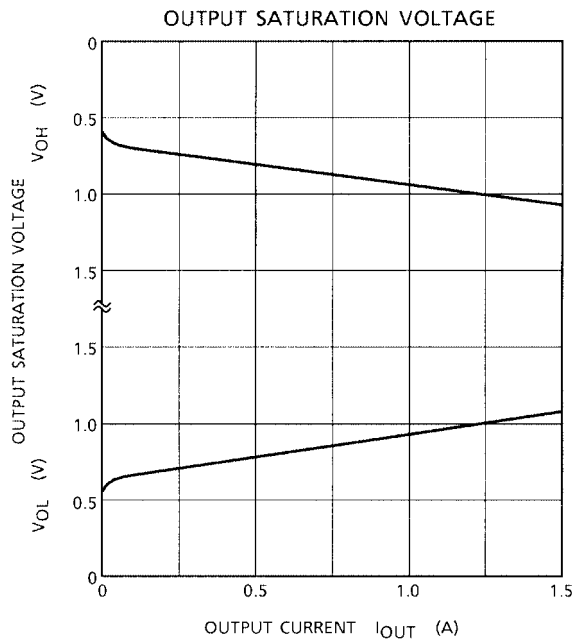


TEST CIRCUIT 5

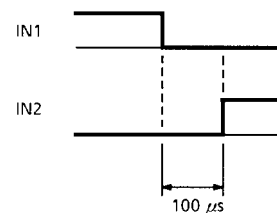
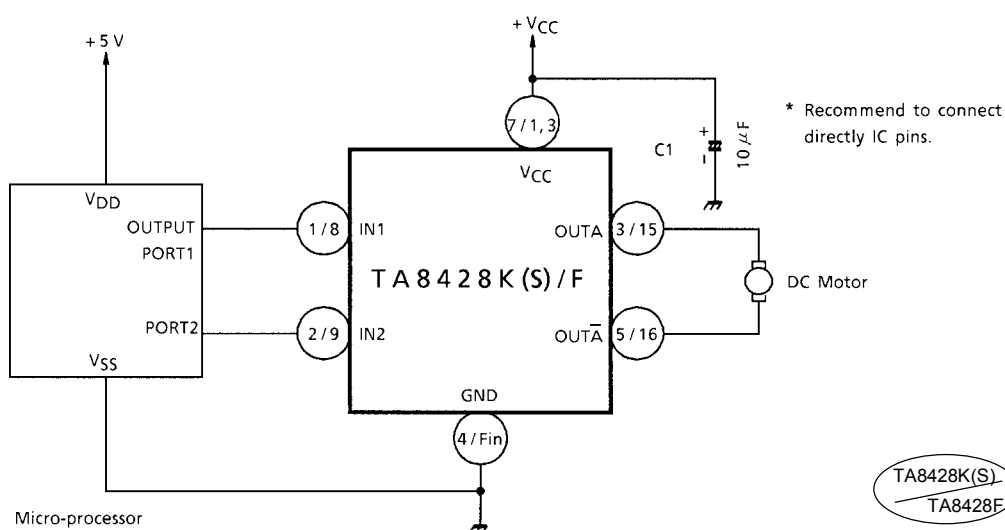
V_{FU} , V_{FL}



TA8428K(S)
TA8428F



APPLICATION CIRCUIT



Note: Recommend to take approximately 100 µs of input dead time for reliable operations.

Note: Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

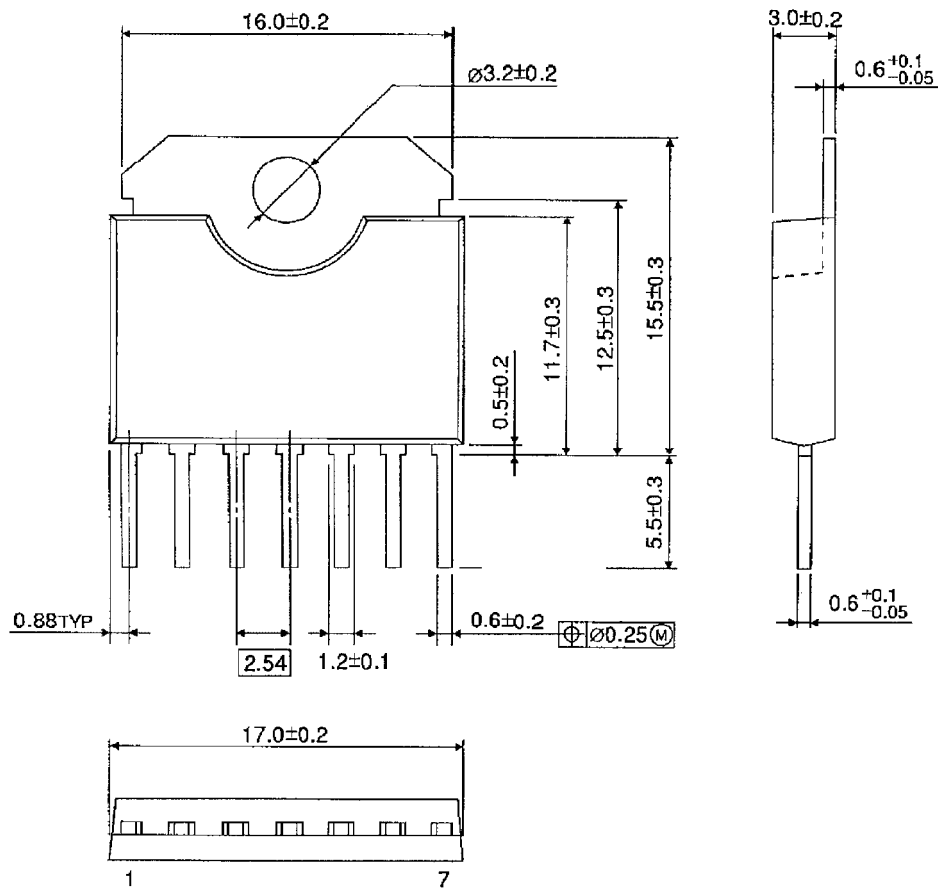
Note: In case of mounted on radiators, do not use silicon rubber. (TA8428K (S))

Note: Connect and use 1 pin and 3 pin surely. (TA8428F)

PACKAGE DIMENSIONS

HSIP7-P-2.54

Unit : mm

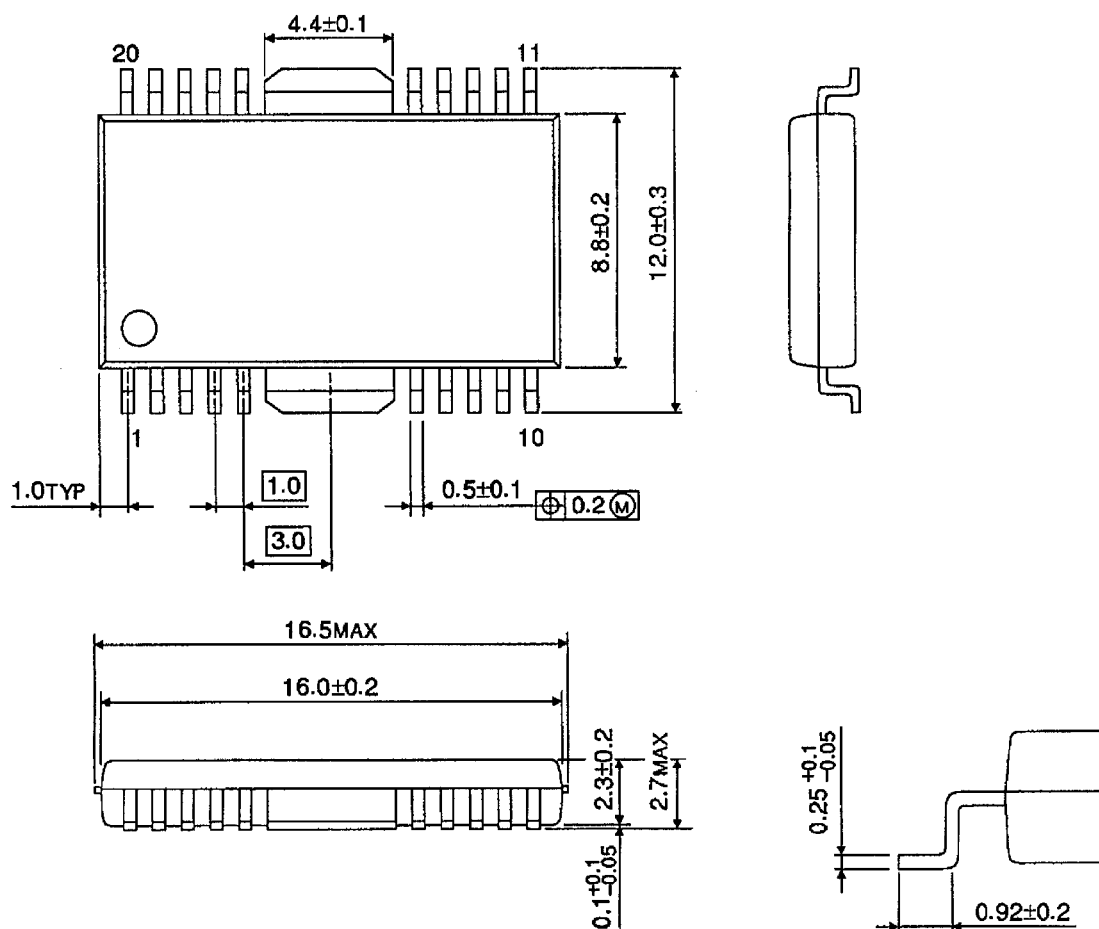


Weight : 1.88 g (Typ.)

PACKAGE DIMENSIONS

HSOP20-P-450-1.00

Unit : mm



Weight : 0.79 g (Typ.)

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000707EBA

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